

UNISONIC TECHNOLOGIES CO., LTD

50NM90-Q Power MOSFET

50A, 900V N-CHANNEL SUPER-JUNCTION MOSFET

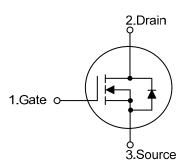
■ DESCRIPTION

The **UTC 50NM90-Q** is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at AC-DC converters for power applications.

■ FEATURES

- * $R_{DS(ON)} \le 0.13 \Omega @ V_{GS} = 10V, I_D = 25A$
- * Fast switching capability
- * Avalanche energy tested
- * Improved dv/dt capability, high ruggedness

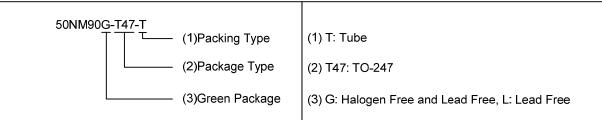
■ SYMBOL



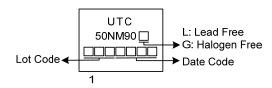
ORDERING INFORMATION

	Ordering Number		Deelses	Pin Assignment			Daakina	
	Lead Free	Halogen Free	Package	1	2	3	Packing	
5	50NM90L-T47-T	50NM90G-T47-T	TO-247	G	D	S	Tube	

Note: Pin Assignment: G: Gate D: Drain S: Source



MARKING



1 TO-247

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50NM90-Q Power MOSFET

■ **ABSOLUTE MAXIMUM RATINGS** (T_C=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		V _{DSS}	900	V	
Gate-Source Voltage		V _{GSS}	±30	V	
Dunin Cumunt	Continuous	ID	50	Α	
Drain Current	Pulsed (Note 2)	I _{DM}	100	Α	
Avalanche Energy	Single Pulsed (Note 3)	Eas	1984	mJ	
Peak Diode Recovery dv/dt (N	lote 4)	dv/dt	6.3	V/ns	
Power Dissipation		P _D	350	W	
Junction Temperature		TJ	+150	°C	
Storage Temperature		T _{STG}	-55 ~ +150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L=100mH, I_{AS}=6.3A, V_{DD}=90V, R_G=25 Ω , Starting T_J = 25°C
- 4. I_{SD} \leq 50A, di/dt \leq 200A/ μ s, V_{DD} \leq BV_{DSS}, Starting T_J = 25°C

■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT	
Junction to Ambient	θ_{JA}	40	°C/W	
Junction to Case	θ_{JC}	0.35	°C/W	

■ **ELECTRICAL CHARACTERISTICS** (T_J=25°C, unless otherwise specified)

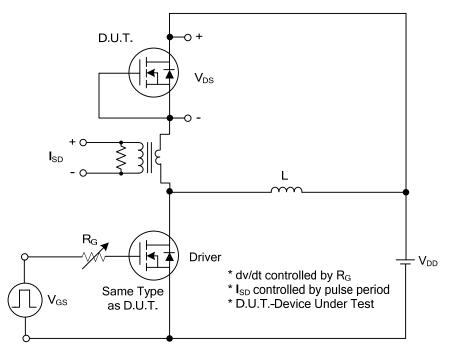
PARAMETER	SYMBOL	TEST CONDITIONS MIN T		TYP	MAX	UNIT			
OFF CHARACTERISTICS									
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250μA	900			V			
Drain-Source Leakage Current	I _{DSS}	V _{DS} =900V, V _{GS} =0V			10	μΑ			
Gate-Source Leakage Current	Igss	V _{GS} =±30V, V _{DS} =0V			±100	nA			
ON CHARACTERISTICS									
Gate Threshold Voltage	$V_{GS(TH)}$	V _{DS} =V _{GS} , I _D =250μA	2.5		4.5	V			
Static Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =25A			0.13	Ω			
DYNAMIC CHARACTERISTICS									
Input Capacitance	Ciss			4665		pF			
Output Capacitance	Coss	V _{GS} =0V, V _{DS} =50V, f=1MHz		502		pF			
Reverse Transfer Capacitance	Crss			8		pF			
SWITCHING CHARACTERISTICS									
Total Gate Charge	Q _G	V 700V V 40V L 50A		180		nC			
Gate-Source Charge	Q _G s	V _{DS} =720V, V _{GS} =10V, I _D =50A (Note 1, 2)		27		nC			
Gate-Drain Charge	Q_{DD}	(Note 1, 2)		78		nC			
Turn-On Delay Time	t _{D(ON)}			24		ns			
Turn-On Rise Time	t_{R}	V _{DD} =100V, V _{GS} =10V,		27		ns			
Turn-Off Delay Time	t _{D(OFF)}	I _D =50A, R _G =25Ω (Note 1, 2)		220		ns			
Turn-Off Fall Time	t⊦			46		ns			
SOURCE- DRAIN DIODE RATINGS AND O	CHARACTER	RISTICS							
Maximum Continuous Drain-Source Diode	ls				50	Α			
Forward Current	IS				30	Α			
Maximum Pulsed Drain-Source Diode	Ism				100	Α			
Forward Current	ISIVI				100				
Drain-Source Diode Forward Voltage	V _{SD}	Is=50A, V _{GS} =0V			1.4	V			
Body Diode Reverse Recovery Time	t _{rr}	Is=30A, V _{GS} =0V,		770		nS			
Body Diode Reverse Recovery Charge	Qrr	dI _F /dt=100A/μs		18		μC			

Notes: 1. Pulse Test: Pulse width \leq 300 μ s, Duty cycle \leq 2%.

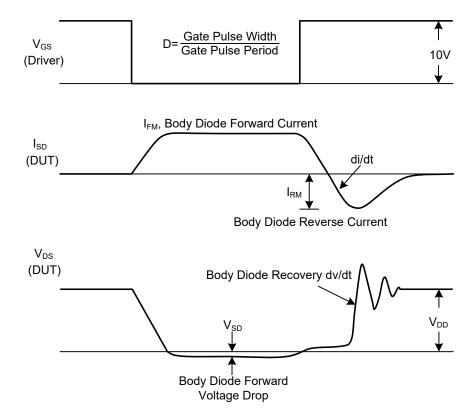
 $2. \ Essentially \ independent \ of \ operating \ temperature.$



■ TEST CIRCUITS AND WAVEFORMS

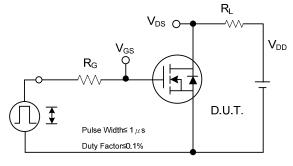


Peak Diode Recovery dv/dt Test Circuit

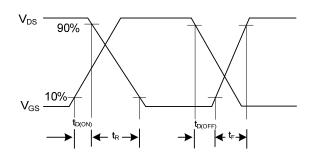


Peak Diode Recovery dv/dt Waveforms

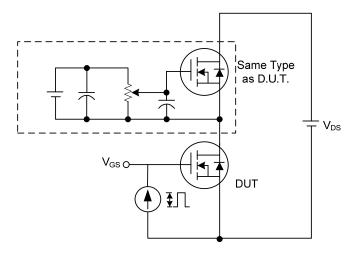
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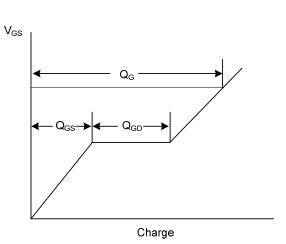
Switching Test Circuit



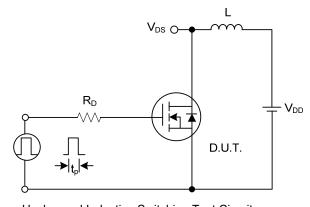
Switching Waveforms



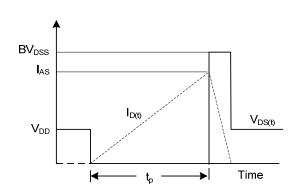
Gate Charge Test Circuit



Gate Charge Waveform



Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

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